

1N4948 2N4949 Silicon annular unijunction transistors

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
RMS Power Dissipation*	P_D	360*	mW
RMS Emitter Current	I_e	50	mA
Peak Pulse Emitter Current**	i_e	1.0**	Amp
Emitter Reverse Voltage	V_{B2E}	30	Volts
Storage Temperature Range	T_{stg}	-65 to +200	$^\circ\text{C}$

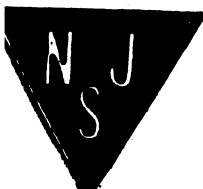
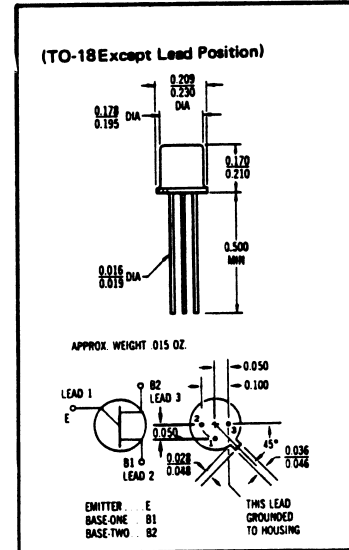
* Derate 2.4 mW/ $^\circ\text{C}$ increase in ambient temperature. Total power dissipation (available power to Emitter and Base-Two) must be limited by external circuitry. Interbase voltage (V_{B2B1}) limited by power dissipation,

$$V_{B2B1} = \sqrt{R_{BB} \cdot P_D}$$

** Capacitance discharge current must fall to 0.37 Amp within 3.0 ms and PRR ≤ 10 PPS.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Intrinsic Standoff Ratio ($V_{B2B1} = 10\text{ V}$) Note 1	η	0.55 0.74	- -	0.82 0.86	-
Interbase Resistance ($V_{B2B1} = 3.0\text{ V}$, $I_E = 0$)	R_{BB}	4.0	7.0	12.0	k ohms
Interbase Resistance Temperature Coefficient ($V_{B2B1} = 3.0\text{ V}$, $I_E = 0$, $T_A = -65^\circ\text{C}$ to $+100^\circ\text{C}$)	αR_{BB}	0.1	-	0.9	%/ $^\circ\text{C}$
Emitter Saturation Voltage ($V_{B2B1} = 10\text{ V}$, $I_E = 50\text{ mA}$) Note 2	$V_{EB1(\text{sat})}$	-	2.5	3.0	Volts
Modulated Interbase Current ($V_{B2B1} = 10\text{ V}$, $I_E = 50\text{ mA}$)	$I_{B2(\text{mod})}$	12	15	-	mA
Emitter Reverse Current ($V_{B2E} = 30\text{ V}$, $I_{B1} = 0$) ($V_{B2E} = 30\text{ V}$, $I_{B1} = 0$, $T_A = 125^\circ\text{C}$)	I_{EB2O}	- -	5.0 -	10 1.0	nA μA
Peak Point Emitter Current ($V_{B2B1} = 25\text{ V}$)	I_P	- -	0.6 0.6	2.0 1.0	μA
Valley Point Current ($V_{B2B1} = 20\text{ V}$, $R_{B2} = 100\text{ ohms}$) Note 2	I_V	2.0	4.0	- -	mA
Base-One Peak Pulse Voltage (Note 3, Figure 3)	V_{OB1}	3.0 6.0	5.0 8.0	- -	Volts
Maximum Oscillation Frequency (Figure 4)	$f_{(\text{max})}$	-	1.25	-	MHz



NOTES

1. Intrinsic standoff ratio.

η is defined by equation:

$$\eta = \frac{V_p - V_{(EB1)}}{V_{B2B1}}$$

Where V_p - Peak Point Emitter Voltage

V_{B2B1} - Interbase Voltage

$V_{(EB1)}$ - Emitter to Base One Junction Diode Drop
(0.5 V @ 10 μ A)

2. Use pulse techniques: PW : 300 μ s duty cycle 2% to avoid internal heating due to interbase modulation which may result in erroneous readings.

3. Base-One Peak Pulse Voltage is measured in circuit of Figure 3. This specification is used to ensure minimum pulse amplitude for applications in SCR firing circuits and other types of pulse circuits.

FIGURE 1 — UNIUNCTION TRANSISTOR SYMBOL AND NOMENCLATURE

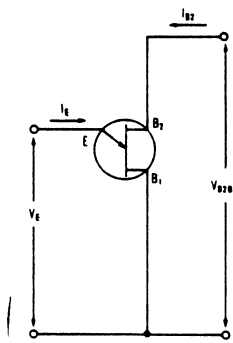


FIGURE 2 — STATIC EMITTER CHARACTERISTIC CURVES

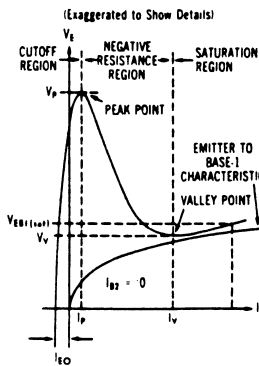


FIGURE 3 — V_{OB1} TEST CIRCUIT
(Typical Relaxation Oscillator)

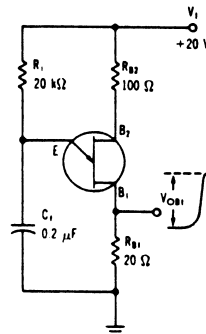


FIGURE 4 — $f_{(max)}$ MAXIMUM FREQUENCY TEST CIRCUIT

